

## **Quarterly Reliability Monitoring Results**

## Quarters: Q1/2022 to Q4/2023

Based on structural similarity

| Supplier Nexperia B.V. Name of Laboratory Assembly reliability labs Based on AEC-Q101 Test |  | User Part Number BZX585-C3V0-Q Part Description      |                      |           |            |           |  |  |                     |  |  |  |  |
|--|--|--|----------------------|-----------|------------|-----------|--|--|---------------------|--|--|--|--|
|  |  |  |                      |           |            |           |  |  | Nexperia DHAM Zener |  |  |  |  |
|  |  |  |                      |           |            |           |  |  | SMD package         |  |  |  |  |
|  |  | Test Conditions                                      | Duration             | # Lots    | # Quantity | # Rejects |  |  |                     |  |  |  |  |
|  |  |  | TEST                 |           |            |           |  |  |                     |  |  |  |  |
|  |  |  | Pre- and Post-Stress |           |            |           |  |  |                     |  |  |  |  |
| # E1   | Electrical Test  | Tamb = 25 °C   | N/A                  | see below | all parts  | see below |  |  |                     |  |  |  |  |
|  |  | JESD22-A113  |                      |           |            |           |  |  |                     |  |  |  |  |
|  |  | Bake Tamb = 125 °C                                   | 24 hours             |           |            |           |  |  |                     |  |  |  |  |
|  | PC   | Soak Tamb = 85 °C, RH = 85%                          | 168 hours            |           |            |           |  |  |                     |  |  |  |  |
| # A1   | Preconditioning  | Reflow soldering                                     | 3 cycles             | 1514      | 64430      | 0         |  |  |                     |  |  |  |  |
|  |  | MIL-STD-750-1  |                      |           |            |           |  |  |                     |  |  |  |  |
|  | HTRB   | M1038 Method A                                       |                      |           |            |           |  |  |                     |  |  |  |  |
|  |  | Tj = Tjmax, VR = 80 % of rated reverse               |                      |           |            | _         |  |  |                     |  |  |  |  |
| # B1   | Bias   | voltage  | 1000 hours           | 250       | 11400      | 0         |  |  |                     |  |  |  |  |
|  |  | MIL-STD-750-1  |                      |           |            |           |  |  |                     |  |  |  |  |
|  |  | M1038 Method B                                       |                      |           |            |           |  |  |                     |  |  |  |  |
| " D41  | SSOP   | Tj = Tjmax, Iz = 100% of max. datasheet              | 10001                |           | 1000       |           |  |  |                     |  |  |  |  |
| # B1b  | Steady State Operational   | reverse current                                      | 1000 hours           | 44        | 1920       | 0         |  |  |                     |  |  |  |  |
|  | T-0  | JECD22 A104  |                      |           |            |           |  |  |                     |  |  |  |  |
|  | TC Temperature Cycling   | JESD22-A104<br>-65 °C to Timax, not to exceed 150°C  | 1000                 | 211       | 1.4000     | 0         |  |  |                     |  |  |  |  |
| # A4   | remperature Cycling  | -63 °C to Tjillax, flot to exceed 130°C              | 1000 cycles          | 311       | 14080      | 0         |  |  |                     |  |  |  |  |
|  | UHAST  | JESD22-A118  |                      |           |            |           |  |  |                     |  |  |  |  |
| # A3 <b>or</b>   | Unbiased HAST  | Tamb = 130 °C, RH = 85 %                             |                      |           |            |           |  |  |                     |  |  |  |  |
| , A3 <b>01</b>   | Olibiased HAST   | · · · · · · · · · · · · · · · · · · ·                | - 96 hours           | 311       | 14080      | 0         |  |  |                     |  |  |  |  |
|  | AC   | JESD22-A102<br>Tamb = 121 °C, RH = 100 %             |                      |           |            |           |  |  |                     |  |  |  |  |
| # A3 alt   | Autoclave  | Pressure = 205 kPa (29.7 psia)                       |                      |           |            |           |  |  |                     |  |  |  |  |
| + A3 all   | Adtociave  | 11e33dre = 203 ki d (23.7 p3id)                      |                      |           |            |           |  |  |                     |  |  |  |  |
|  | H3TRB  | JESD22-A101  |                      |           |            |           |  |  |                     |  |  |  |  |
|  | High Humidity High   | Tamb = 85 °C, RH = 85%, VR = 80 % of                 |                      |           |            |           |  |  |                     |  |  |  |  |
| # A2 alt   |  | rated reverse voltage <sup>[1]</sup>                 | 1000 hours           | 311       | 14080      | 0         |  |  |                     |  |  |  |  |
| , AL die   |  | MIL-STD-750 Method 1037                              |                      |           |            | -         |  |  |                     |  |  |  |  |
|  | IOL  | ton = toff, devices powered to insure $\Delta T_j$ = |                      |           |            |           |  |  |                     |  |  |  |  |
| # A5   | Intermittent Operating Life  |  | 1000 hours           | 312       | 14120      | 0         |  |  |                     |  |  |  |  |
|  | and the same and t |  | _500                 |           | 120        | -         |  |  |                     |  |  |  |  |
|  | RSH  | JESD22-A111  |                      |           |            |           |  |  |                     |  |  |  |  |
| # C8   | Resistance to Solder Heat  | 260 °C ± 5 °C  | 10 s                 | 269       | 8070       | 0         |  |  |                     |  |  |  |  |
|  | SD   |  | _, ,                 | _05       | -0.0       | -         |  |  |                     |  |  |  |  |
| # C10  | Solderability  | J-STD-002  |                      | 19        | 6660       | 0         |  |  |                     |  |  |  |  |

<sup>[1]</sup> The maximum applied voltage is limited by test chamber set up and does not exceed 115V.

## **Calculation of FIT and MTTF**

Test considered for FIT calculation: High Temperature Reverse Bias (HTRB, Test #B1) Confidence level 60%, derated to 55 °C, activation energy 0.7 eV, test time 168 to 1000 hours

| Wafer Fab | Technology | Quantity | Rejects | Failure Rate (FIT) | MTTF (hrs) |
|-----------|------------|----------|---------|--------------------|------------|
| Nexperia  |            |          |         |                    |            |
| DHAM      | Zener      | 11400    | 0       | 0,37               | 2,68E+09   |

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